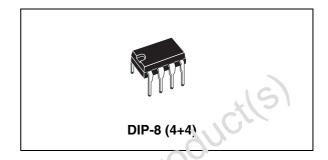


### **TDA7267T**

## 2 W mono amplifier

### **Features**

- 2 W output power into 8  $\Omega$  at 12 V, THD = 10%
- Internally fixed gain of 32 dB
- No feedback capacitor
- No boucherot cell
- Thermal protection
- AC short-circuit protection
- SVR capacitor for better ripple rejection
- Low turn-on/off "pop" noise
- Standby mode



### **Description**

The TDA726.1 's a new technology mono audio amplifier ir. a DIP-8 package specifically designed for TV at plications.

Thanks to the fully complementary output configuration the device delivers a rail-to-rail voltage swing without the need for boostrap capacitors.

Table 1. Device summary

Order code	Order code		Packaging
TDA7267T	C to 70° C	DIP-8 (4+4)	Tube
7 9%			
der			
a1050			
OP			

# 1 Block diagram and applications circuit

Figure 1. Applications circuit showing internal block diagram

V<sub>S</sub>=12V

100 F

470 F

OUT

OUT

D94AU165

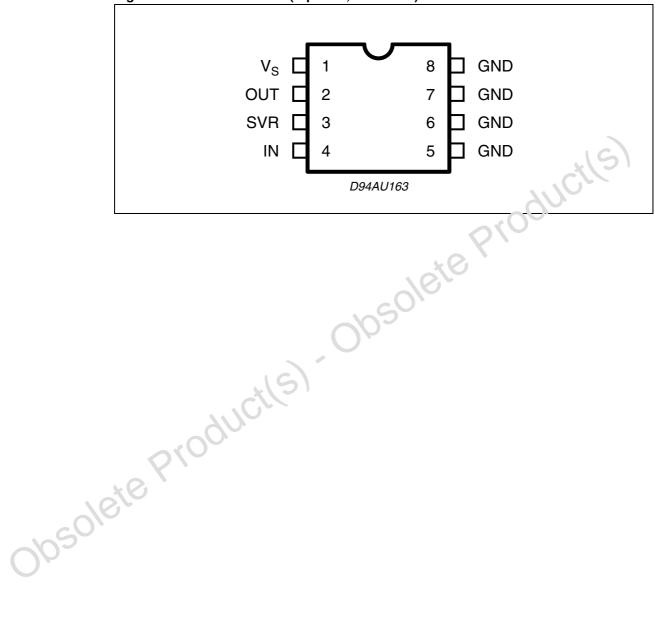
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Obsolete Product(s)

TDA7267T Pin description

# 2 Pin description

Figure 2. Pin connection (top view, PCB view)



#### **Electrical specifications** 3

#### 3.1 **Absolute maximum ratings**

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	
V <sub>S</sub>	DC supply voltage	18	٧
I <sub>O</sub>	Peak output current	1.5	Α
T <sub>op</sub>	Operating temperature range	0 to 70	°C
Tj	Junction temperature	150	c
T <sub>stg</sub>	Storage temperature range	-40 to 150	°C

#### 3.2 Thermal data

Table 3. Thermal data

·sig	Otorago temperaturo rango		.00		
Thermal data					
Table 3.	Thermal data				
Symbol	Parameter		Тур	Max	Unit
R <sub>th j-amb</sub>	Thermal resistance, junction to ambier (5): PCB)		76	-	°C/W
R <sub>th j-case</sub>	Thermal resistance, junction to case pin (6 or 7)		23	-	°C/W

#### Electrical specifications 3.3

Unless otherwise stated, the results in *Table 4* below are given for the conditions:  $V_S = 12 \text{ V}$ ,  $R_L = 8 \Omega$ , f = 1 I.H. and  $Tamb = 25^{\circ} \text{ C.}$ 

Table 4. Electrical specifications

Symbol	Parameter	Condition	Min	Тур	Max	Unit
I V <sub>S</sub>	Supply voltage range	-	4.5	-	18	V
Iq	Total quiescent current	-	-	20	30	mA
I <sub>STBY</sub>	Current in standby	Pin 3 shorted to GND	-	-	0.3	mA
Vo	Quiescent output voltage	-	-	6	-	٧
A <sub>V</sub>	Voltage gain	-	-	32	-	dB
R <sub>IN</sub>	Input resistance	-	-	100	-	kΩ
Po	Output power	THD = 10%	1.8	2.0	-	W
THD	Total harmonic distortion	P <sub>O</sub> = 1 W	-	-	1.0	%
SVR	Supply voltage rejection	f <sub>ripple</sub> = 1 kHz, V <sub>ripple</sub> = 150 mV RMS	-	50	-	dB

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Table 4. Electrical specifications (continued)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
E <sub>I</sub>	Input noise voltage	$R_G = 10 \text{ k}\Omega$ , BW = 20 Hz to 20 kHz	-	1.5	5.0	μV
$V_{STBY}$	Standby enable voltage	-	-	-	1.0	٧



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#### **Applications information** 4

For 12-V supply and 8- $\Omega$  speaker applications the maximum power dissipation is approximately 1.2 W.

Assuming that the maximum ambient temperature is 70° C the required thermal resistance of the devices must be equal to (150 - 70) / 1.2 = 67 °C/W.

The junction-to-pin thermal resistance of the package is about 23 °C/W. This means that an external heatsink of around 43 °C/W is required.

The copper ground plane of the PCB can be used for dissipating this heat.

Standby switches must be able to discharge the  $C_{SVR}$  current.

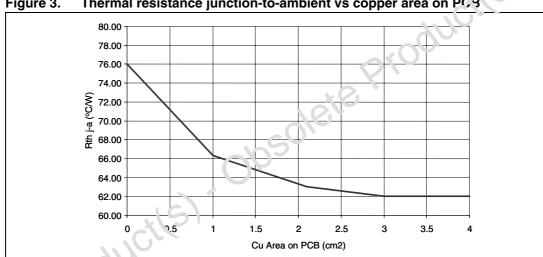
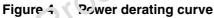
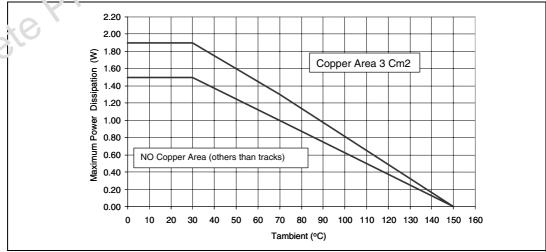


Figure 3. Thermal resistance junction-to-ambient vs copper area on PG3





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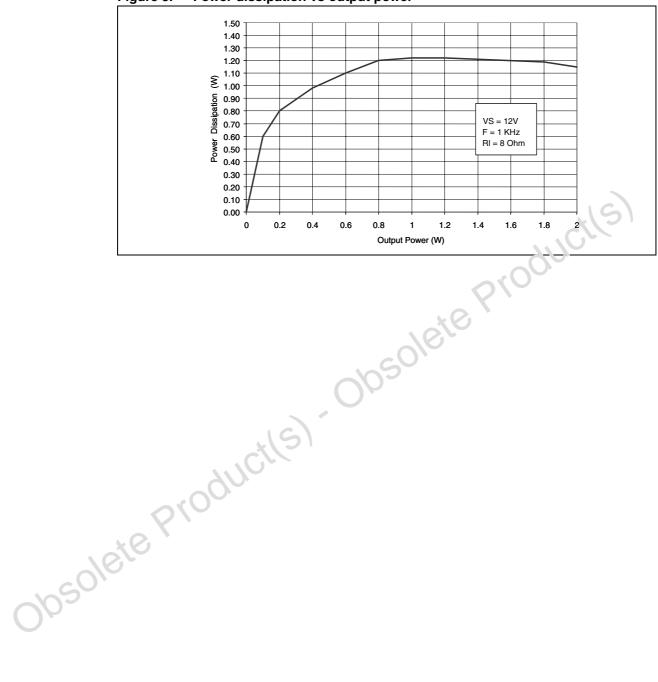


Figure 5. Power dissipation vs output power

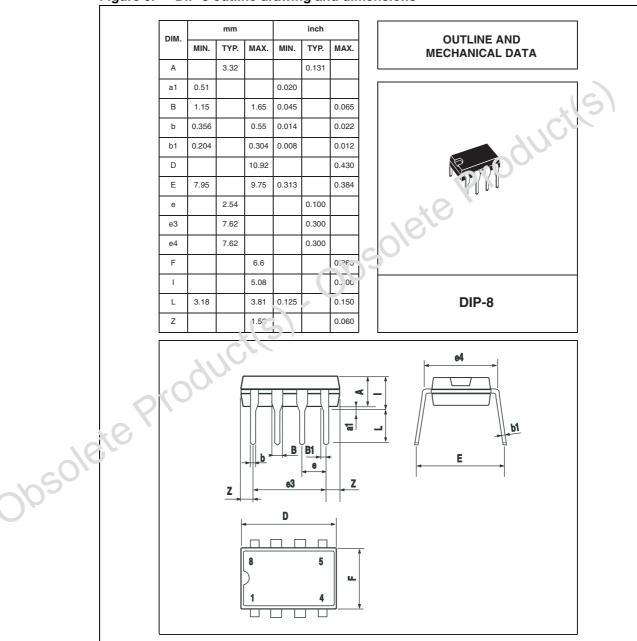
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### 5 Package mechanical data

The TDA7267T comes in a 8-pin DIP package.

Figure 6 below gives the package outline and dimensions.

Figure 6. DIP-8 outline drawing and dimensions



In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

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TDA7267T Revision history

# 6 Revision history

Table 5. Document revision history

Date	Revision	Changes
Dec-2005	1	Initial release.
29-May-2009	2	Updated temperature to 70° C in <i>Chapter 4 on page 6</i> .



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